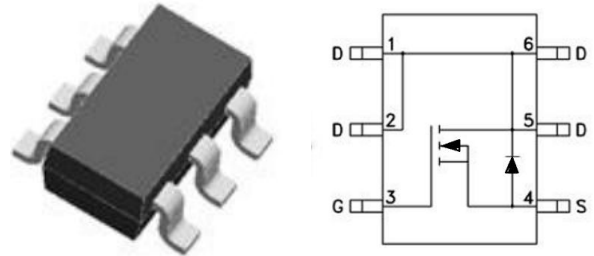


**SOT-23-6L 60V N Channel Enhancement 沟道增强型
MOS Field Effect Transistor 场效应管**



■ **Absolute Maximum Ratings 最大额定值**

Characteristic 特性参数	Symbol 符号	Rat 额定值	Unit 单位
Drain-Source Voltage 漏极-源极电压	BV_{DSS}	60	V
Gate- Source Voltage 栅极-源极电压	V_{GS}	± 20	V
Drain Current (continuous)漏极电流-连续	I_D (at $T_A = 25^\circ C$)	3	A
Drain Current (pulsed)漏极电流-脉冲	I_{DM}	13	A
Total Device Dissipation 总耗散功率	P_D (at $T_A = 25^\circ C$)	1200	mW
Thermal Resistance Junction-Ambient 热阻	$R_{\theta JA}$	104	$^\circ C/W$
Junction/Storage Temperature 结温/储存温度	T_J, T_{stg}	-55~150	$^\circ C$

■ **Device Marking 产品字标**

FS6420=6420

■ Electrical Characteristics 电特性

($T_A=25^{\circ}\text{C}$ unless otherwise noted 如无特殊说明, 温度为 25°C)

Characteristic 特性参数	Symbol 符号	Min 最小值	Typ 典型值	Max 最大值	Unit 单位
Drain-Source Breakdown Voltage 漏极-源极击穿电压($I_D=250\mu\text{A}, V_{GS}=0\text{V}$)	BV_{DSS}	60	—	—	V
Gate Threshold Voltage 栅极开启电压($I_D=250\mu\text{A}, V_{GS}=V_{DS}$)	$V_{GS(th)}$	0.9	1.3	2	V
Zero Gate Voltage Drain Current 零栅压漏极电流($V_{GS}=0\text{V}, V_{DS}=60\text{V}$)	I_{DSS}	—	—	1	μA
Gate Body Leakage 栅极漏电流($V_{GS}=\pm 20\text{V}, V_{DS}=0\text{V}$)	I_{GSS}	—	—	± 100	nA
Static Drain-Source On-State Resistance 静态漏源导通电阻($I_D=3\text{A}, V_{GS}=10\text{V}$) ($I_D=2\text{A}, V_{GS}=4.5\text{V}$)	$R_{DS(ON)}$	—	86 92	100 120	$\text{m}\Omega$
Diode Forward Voltage Drop 内附二极管正向压降($I_{SD}=3\text{A}, V_{GS}=0\text{V}$)	V_{SD}	—	—	1.2	V
Input Capacitance 输入电容 ($V_{GS}=0\text{V}, V_{DS}=30\text{V}, f=1\text{MHz}$)	C_{ISS}	—	410	—	pF
Common Source Output Capacitance 共源输出电容($V_{GS}=0\text{V}, V_{DS}=30\text{V}, f=1\text{MHz}$)	C_{OSS}	—	50	—	pF
Reverse Transfer Capacitance 反馈电容($V_{GS}=0\text{V}, V_{DS}=30\text{V}, f=1\text{MHz}$)	C_{RSS}	—	41	—	pF
Total Gate Charge 栅极电荷密度 ($V_{DS}=3\text{V}, I_D=3\text{A}, V_{GS}=10\text{V}$)	Q_g	—	11	—	nC
Gate Source Charge 栅源电荷密度 ($V_{DS}=3\text{V}, I_D=3\text{A}, V_{GS}=10\text{V}$)	Q_{gs}	—	2	—	nC
Gate Drain Charge 栅漏电荷密度 ($V_{DS}=3\text{V}, I_D=3\text{A}, V_{GS}=10\text{V}$)	Q_{gd}	—	2	—	nC
Turn-ON Delay Time 开启延迟时间 ($V_{DS}=10\text{V}, I_D=3\text{A}, R_{GEN}=3\Omega, V_{GS}=10\text{V}$)	$t_{d(on)}$	—	4	—	ns
Turn-ON Rise Time 开启上升时间 ($V_{DS}=15\text{V}, I_D=5.6\text{A}, R_{GEN}=3\Omega, V_{GS}=10\text{V}$)	t_r	—	18	—	ns
Turn-OFF Delay Time 关断延迟时间 ($V_{DS}=15\text{V}, I_D=5.6\text{A}, R_{GEN}=3\Omega, V_{GS}=10\text{V}$)	$t_{d(off)}$	—	13	—	ns
Turn-OFF Fall Time 关断下降时间 ($V_{DS}=15\text{V}, I_D=5.6\text{A}, R_{GEN}=3\Omega, V_{GS}=10\text{V}$)	t_f	—	23	—	ns

■ Typical Characteristic Curve 典型特性曲线

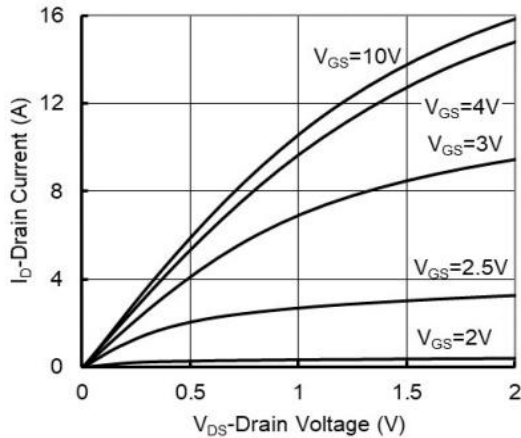


Figure 1: Output Characteristics

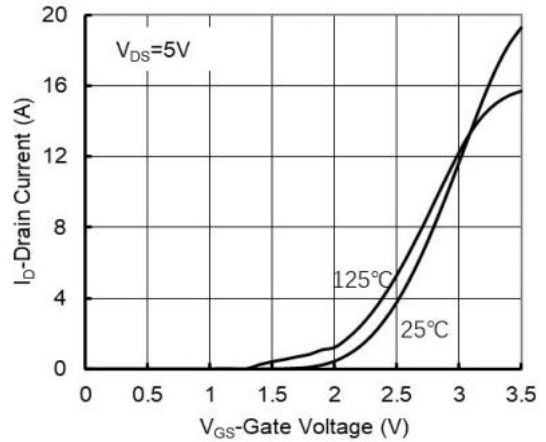


Figure 2: Transfer Characteristics

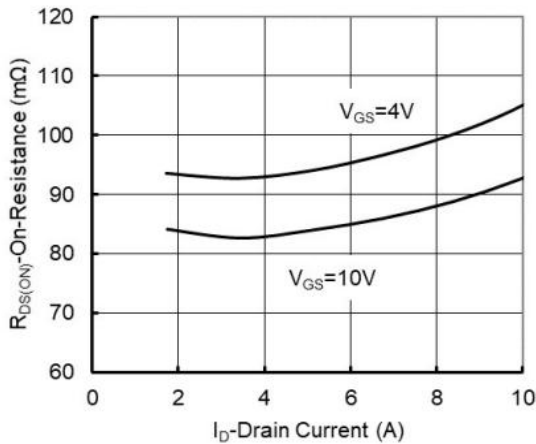


Figure 3: On-Resistance vs. Drain Current

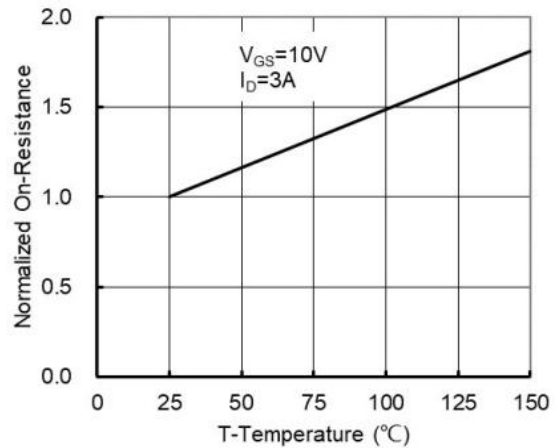


Figure 4: On-Resistance vs. Temperature

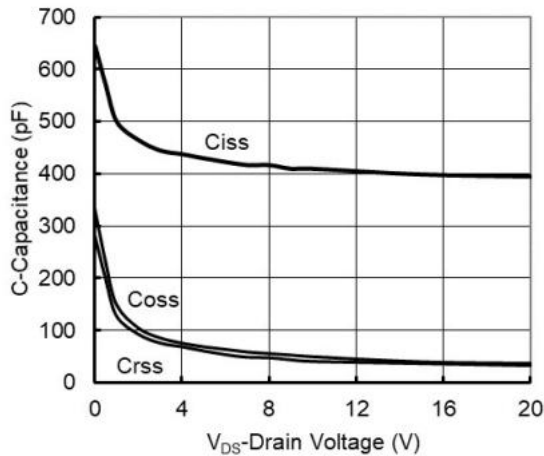


Figure 5: Capacitance Characteristics

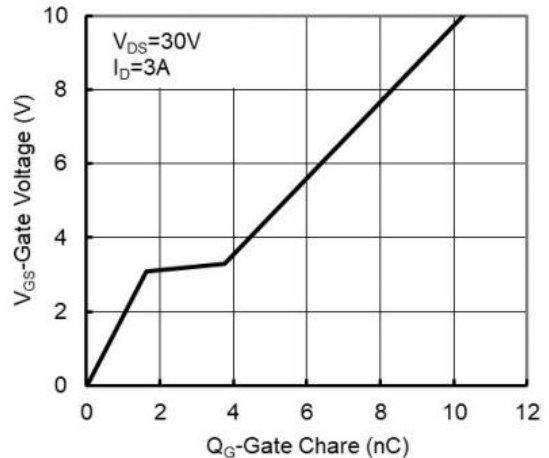


Figure 6: Gate-Charge Characteristics

■ Typical Characteristic Curve 典型特性曲线

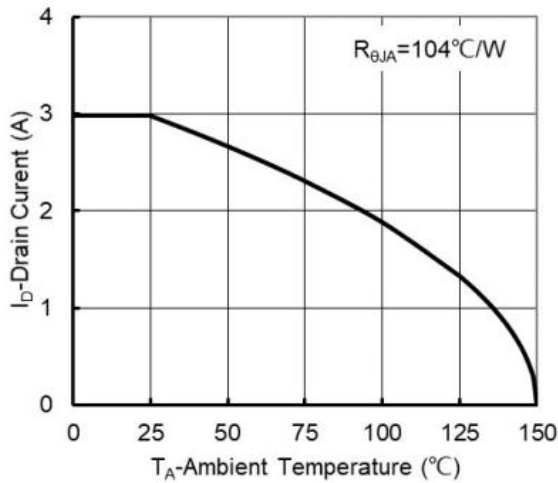


Figure 7: Drain Current vs. Temperature

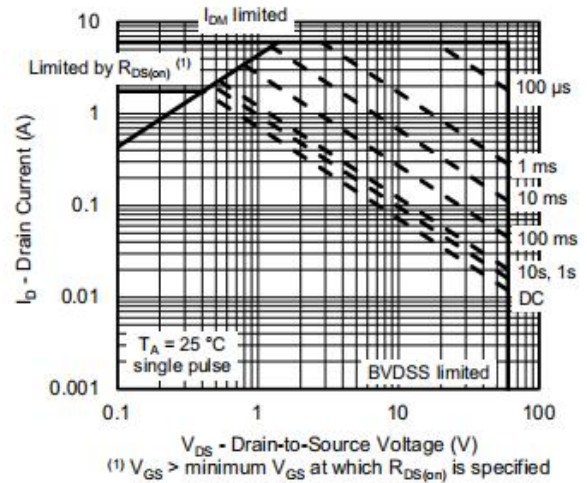


Figure 8: Safe Operating Area

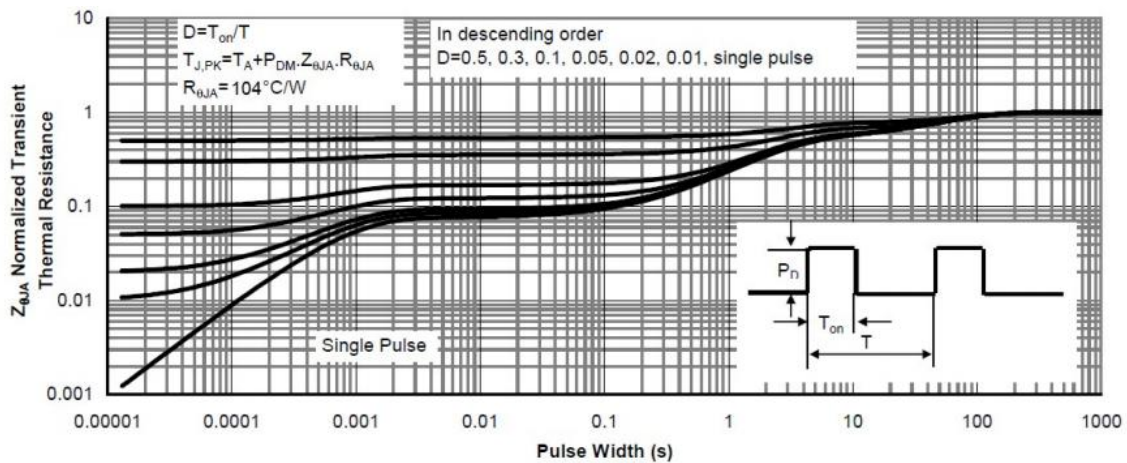
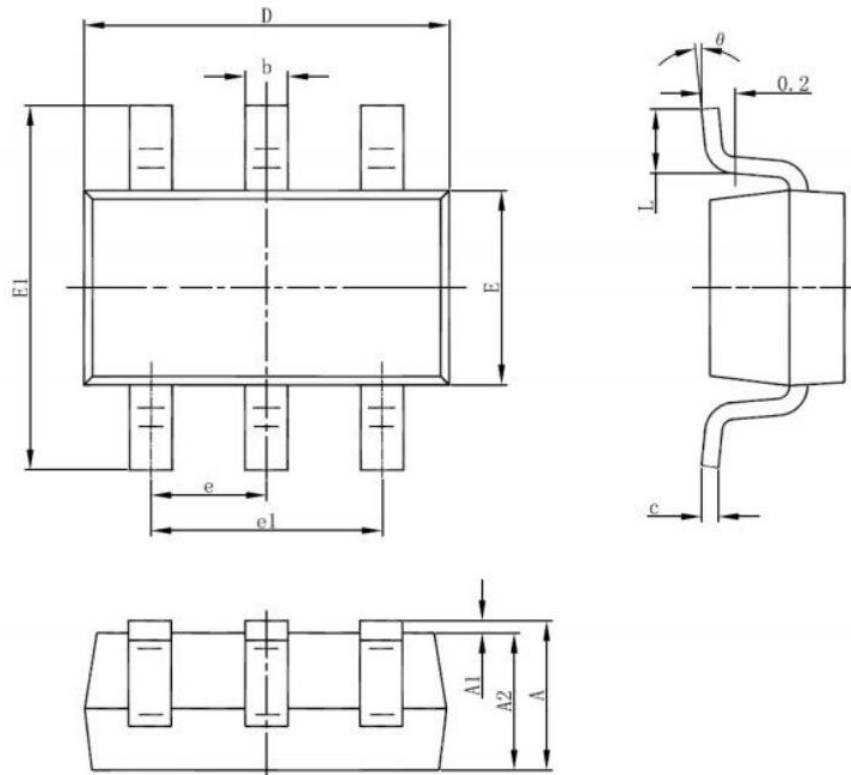


Figure 9: Transient Thermal Response Curve

■ Dimension 外形封装尺寸



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.050	1.250	0.041	0.049
A1	0.000	0.100	0.000	0.004
A2	1.050	1.150	0.041	0.045
b	0.300	0.500	0.012	0.020
c	0.100	0.200	0.004	0.008
D	2.820	3.020	0.111	0.119
E	1.500	1.700	0.059	0.067
E1	2.650	2.950	0.104	0.116
e	0.900	1.00	0.035	0.039
e1	1.800	2.000	0.071	0.079
L	0.450	0.650	0.018	0.026
L1	0.300	0.600	0.012	0.024
θ	0°	8°	0°	8°